# YIBO LIN

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#### RESEARCH INTERESTS

Nanometer IC design for manufacturability, modeling and optimization in VLSI CAD

#### **EDUCATION**

# University of Texas at Austin, TX, USA Ph.D. student, Department of Electrical and Computer Engineering Advisor: David Z. Pan (GPA 3.96/4.0) Shanghai Jiao Tong University, Shanghai, P.R.China B.S., Department of Microelectronics (GPA 91.17/100)

#### **EXPERIENCE**

(Rank top 1/60)

IMEC, Leuven, Belgium Internship Design technology co-optimization for emerging lithography options	Sep. 2016 - Nov. 2016
Chinese University of Hong Kong, China Summer Intern Quantum computing	Jun.2016-Aug.2016
Cadence Design System, TX, USA Summer Intern Routability driven detailed placement	$May\ 2015 - Aug.\ 2015$
Oracle Inc., TX, USA Summer Intern Incremental timing driven detailed placement	$May\ 2014\ -\ Aug.\ 2014$
ECE Department, University of Texas at Austin, TX, USA Graduate Research Assistant Multiple patterning lithography layout decomposition Stitch aware detailed placement Triple-patterning aware detailed placement Dummy fill insertion Detailed-routing-driven placement	Jan. 2014 – Present

#### **PUBLICATIONS**

#### Journal Papers

- [J3] Yibo Lin, Bei Yu and David Z. Pan, "High Performance Dummy Fill Insertion with Coupling and Uniformity Constraints", IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2016. (submitted)
- [J2] Bei Yu, Xiaoqing Xu, Subhendu Roy, Yibo Lin, Jiaojiao Ou, and David Z. Pan, "Design for Manufacturability and Reliability in Extreme-Scaling VLSI", Science China Information Sciences, 2016 (Invited paper)

[J1] Bei Yu, Xiaoqing Xu, Jhih-Rong Gao, **Yibo Lin**, Zhuo Li, Charles Alpert, and David Z. Pan, "Methodology for Standard Cell Compliance and Detailed Placement for Triple Patterning Lithography", IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), vol.34, no.5, pp.726-739, 2015.

#### Conference Papers

- [C8] Yudong Tao, Changhao Yan, Yibo Lin, Shengguo Wang, David Z. Pan, and Xuan Zeng, "A Novel Unified Dummy Fill Insertion Framework with SQP-Based Optimization Method", IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov. 7-10, 2016 (to appear)
- [C7] Yibo Lin, Bei Yu, Xiaoqing Xu, Jhih-Rong Gao, Natarajan Viswanathan, Wen-Hao Liu, Zhuo Li, Charles J. Alpert and David Z. Pan, "MrDP: Multiple-row Detailed Placement of Heterogeneous-sized Cells for Advanced Nodes", IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov. 7-10, 2016 (to appear)
- [C6] Yibo Lin, Bei Yu, and David Z. Pan, "Detailed Placement In Advanced Technology Nodes: A Survey", IEEE International Conference on Solid -State and Integrated Circuit Technology (ICSICT), Hangzhou, China, Oct. 25-28, 2016 (Invited paper) (to appear)
- [C5] Yibo Lin, Xiaoqing Xu, Bei Yu, Ross Baldick, and David Z. Pan, "Triple/Quadruple Patterning Layout Decomposition via Novel Linear Programming and Iterative Rounding", SPIE Advanced Lithography Conference, San Jose, CA, Feb. 21-25, 2016 (Best Student Paper Award)
- [C4] Yibo Lin, Bei Yu, Yi Zou, Zhuo Li, Charles J. Alpert and David Z. Pan, "Stitch Aware Detailed Placement for Multiple E-Beam Lithography", IEEE/ACM Asian and South Pacific Design Automation Conference (ASPDAC), Macau, Jan. 25-28, 2016.
- [C3] Yibo Lin, Bei Yu, Biying Xu and David Z. Pan, "Triple Patterning Aware Detailed Placement Toward Zero Cross-Row Middle-of-Line Conflict", IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov. 2-6, 2015.
- [C2] David Z. Pan, Lars Liebmann, Bei Yu, Xiaoqing Xu and Yibo Lin, "Pushing Multiple Patterning in Sub-10nm: Are We Ready?", ACM/IEEE Design Automation Conference (DAC), pp. 197:1-197:6, San Francisco, CA, June 7-11, 2015. (Invited Paper)
- [C1] Yibo Lin, Bei Yu and David Z. Pan, "High Performance Dummy Fill Insertion with Coupling and Uniformity Constraints", ACM/IEEE Design Automation Conference (DAC), pp. 71:1-71:6, San Francisco, CA, June 7-11, 2015.

#### RELATED COURSES

• EE382M: VLSI I	Prof. Michael Orshansky
• EE382N: Computer Architecture	Prof. Aater Suleman
• EE382V: Optimization Issues in VLSI CAD	Prof. David Pan
• EE382M: VLSI II	Prof. Jacob Abraham
• EE380L: Engineer Programming Languages	Prof. Craig Chase
• EE382V: Nanometer Scale IC Design	Prof. Michael Orshansky
• EE382V: VLSI Physical Design Automation	Prof. David Pan
• EE381V: Advanced Algorithms	Prof. Evdokia Nikolova
• EE382V: Advanced Programming Tools	Prof. Aziz Adnan
• EE380N: Optimization in Engineering Systems	Prof. Ross Baldick
• CS383C: Numerical Analysis: Linear Algebra	Prof. Robert van de Geijn

#### **SKILLS**

## Web Development

HTML5, JavaScript/jQuery

# EDA Tools

Cadence Virtuoso, Synopsys Design Compiler, Synopsys IC Compiler

### AWARDS AND HONORS

Franco Cerrina Memorial Best Student Paper Award	SPIE	2016
A. Richard Newton Young Student Fellow	DAC	2014
National Scholarship	Shanghai Jiao Tong University	2012
Samsung Scholarship	Shanghai Jiao Tong University	2011
The Second Prize Scholarship	Shanghai Jiao Tong University	2010